FAIRCHILD SEMICONDUCTOR®

FDC2612 200V N-Channel PowerTrench[®] MOSFET

General Description

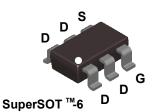
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed.

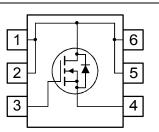
Applications

DC/DC converter

Features

- 1.1 A, 200 V. $R_{DS(ON)}$ = 725 m Ω @ V_{GS} = 10 V
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability
- Fast switching speed
- Low gate charge (8nC typical)





Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter			Ratings		
V _{DSS}	Drain-Source	ce Voltage		200	V	
V _{GSS}	Gate-Sourc	e Voltage		± 20		
ID	Drain Curre	nt – Continuous	(Note 1a)	1.1	A	
		 Pulsed 		4		
P _D	Maximum Power Dissipation		(Note 1a)	1.6	W	
			(Note 1b)	0.8		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150		
	Thermal Re	teristics sistance, Junction-to-Am	bient (Note 1a)	78	°C/W	
R _{θJA}	Thermal Re		, ,	78 30		
R _{θJA} R _{θJC}	Thermal Re Thermal Re	sistance, Junction-to-Am	Se (Note 1)		_	
R _{əja} R _{əjc} Packag	Thermal Re Thermal Re	sistance, Junction-to-Am sistance, Junction-to-Cas	Se (Note 1)		°C/W °C/W Quantity	

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FDC2612

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Char	acteristics					1
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	200			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		246		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 160 V, V _{GS} = 0 V			1	μA
I _{GSSF}	Gate-Body Leakage, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate–Body Leakage, Reverse	$V_{GS} = -20 \text{ V}$, $V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)	·				•
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	2	4	4.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		-8.7		mV/°C
R _{DS(on)}	Static Drain–Source On Resistance	V_{GS} = 10 V, I_D = 1.1 A V_{GS} = 10 V, I_D = 1.1 A, T_J = 125°C		605 1133	725 1430	mΩ
I _{D(on)}	On–State Drain Current	V_{GS} = 10 V, V_{DS} = 10 V	4			А
g FS	Forward Transconductance	V _{DS} = 10 V, I _D = 1.1 A		4.4		S
Dynamie	c Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 100 V$, $V_{GS} = 0 V$,		234		pF
Coss	Output Capacitance	f = 1.0 MHz		18		pF
C _{rss}	Reverse Transfer Capacitance	1		8		pF
Switchir	ng Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 100 V$, $I_D = 1 A$,		6	12	ns
tr	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		6	12	ns
t _{d(off)}	Turn–Off Delay Time	1		17	30	ns
t _f	Turn–Off Fall Time	1		8	16	ns
Qg	Total Gate Charge	$V_{DS} = 100 V$, $I_D = 1.1 A$,		8	11	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V		1.6		nC
Q _{gd}	Gate-Drain Charge	1		2.2		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain-Source				1.3	Α
V _{SD}	Drain–Source Diode Forward Voltage	V_{GS} = 0 V, I_{S} = 1.3 A(Note 2)		0.8	1.2	V
rr	Diode Reverse Recovery Time	I _F = 1.1A,		74.5		nS
) Ju	Diode Reverse Recovery Charge $d_{iF}/d_t = 300 \text{ A/}\mu\text{s}$ (Note 2)			194		nC



a) 78°C/W when mounted on a 1in² pad of 2 oz copper

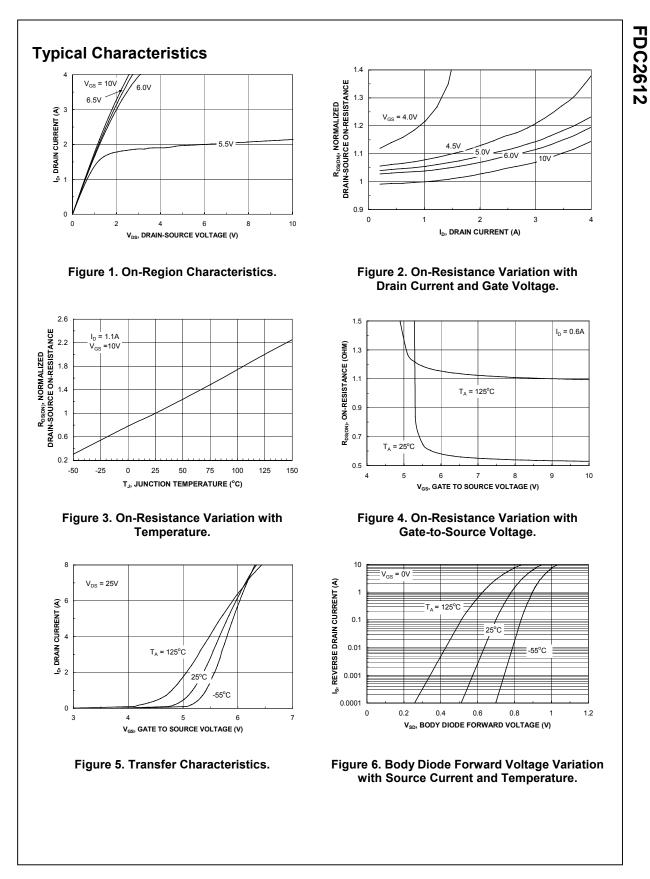


b) 156°C/W when mounted on a minimum pad of 2 oz copper

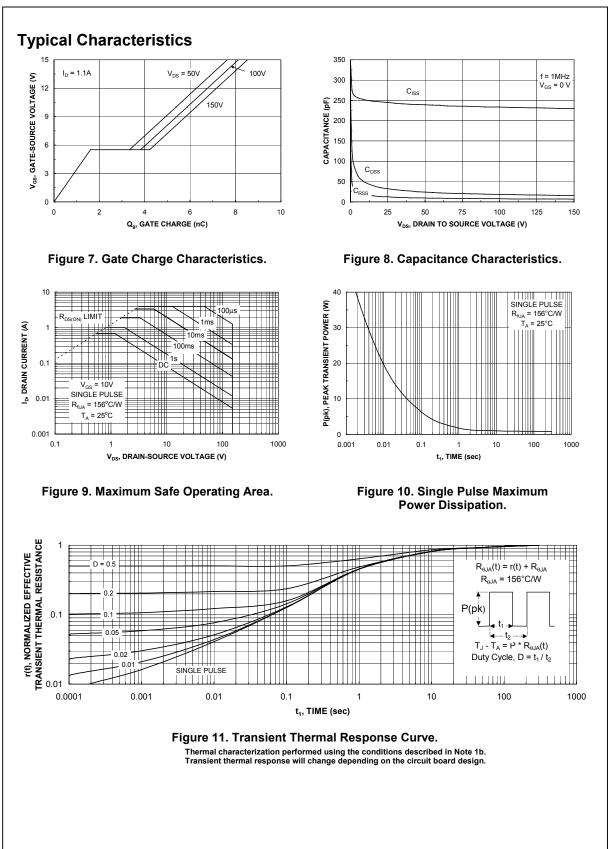
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%

FDC2612 Rev B3(W)



FDC2612 Rev B3(W)



FDC2612 Rev B3(W)

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